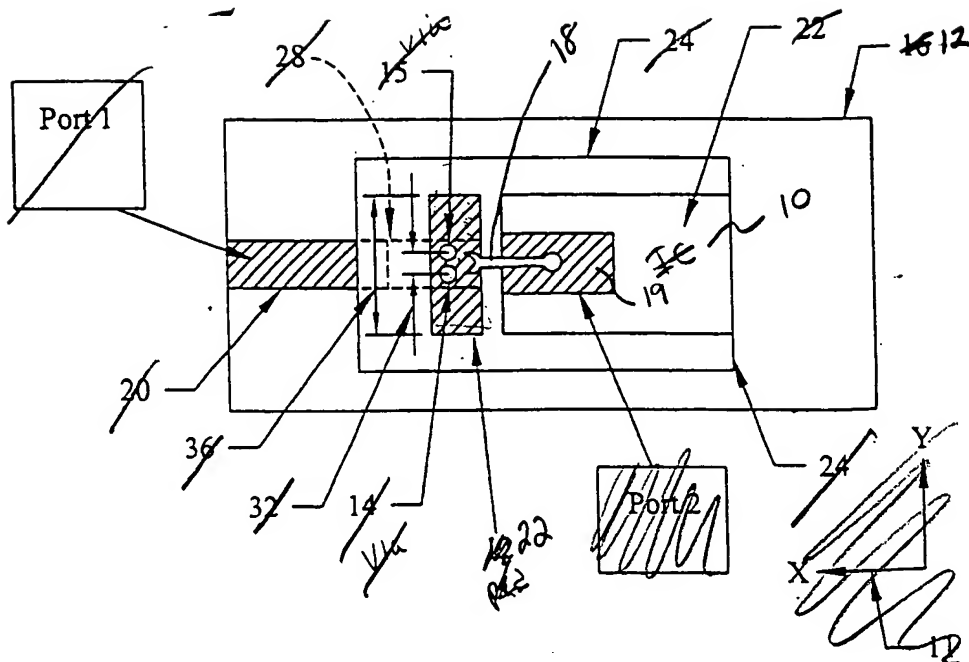


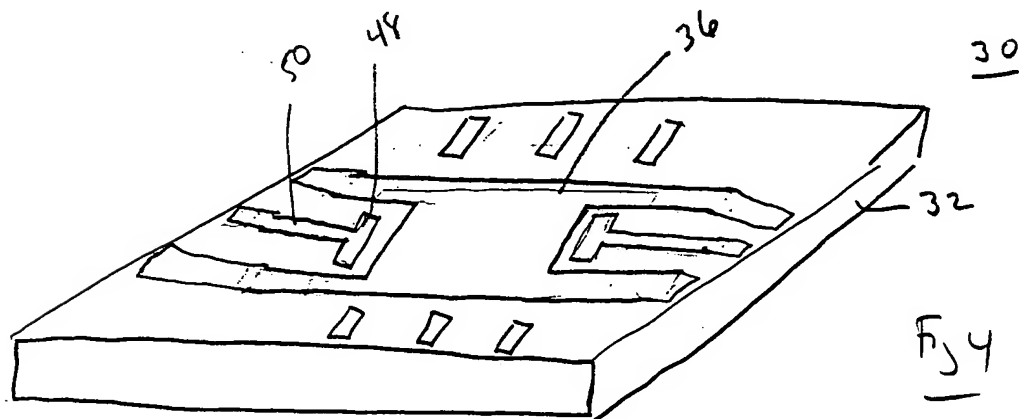
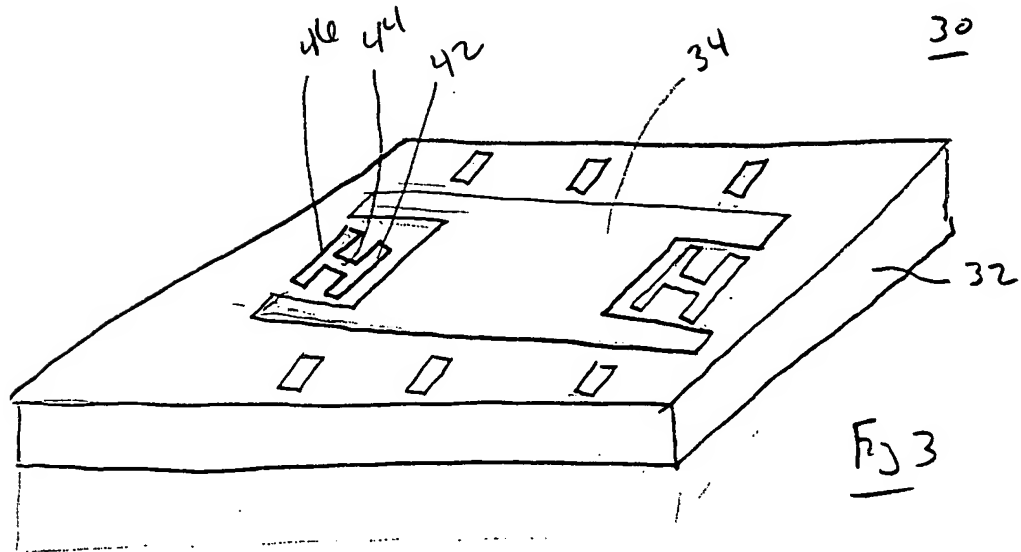
Fig. 1

ZdF10

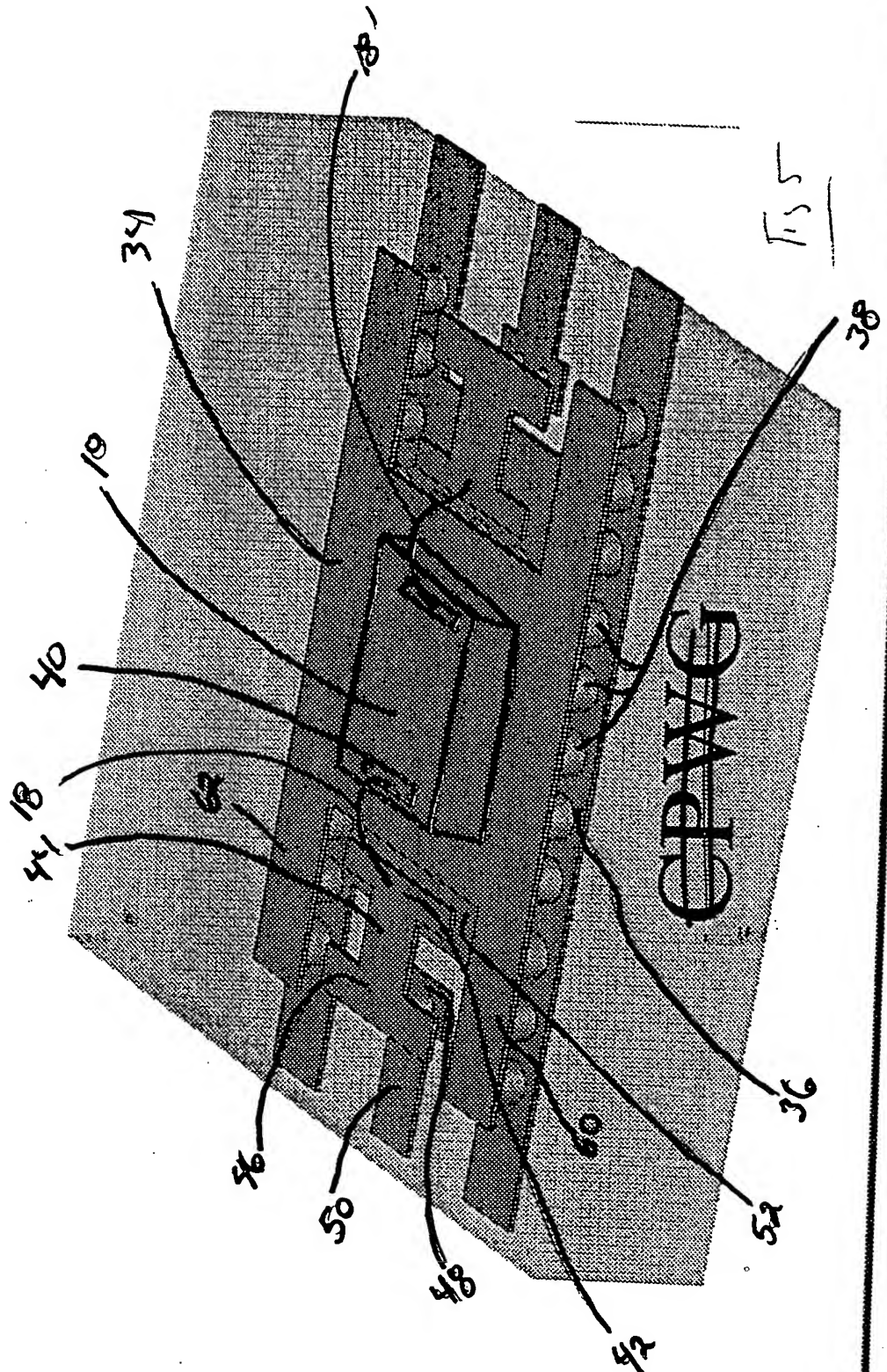


F<sub>2</sub> 2  
(PRIOR ART)

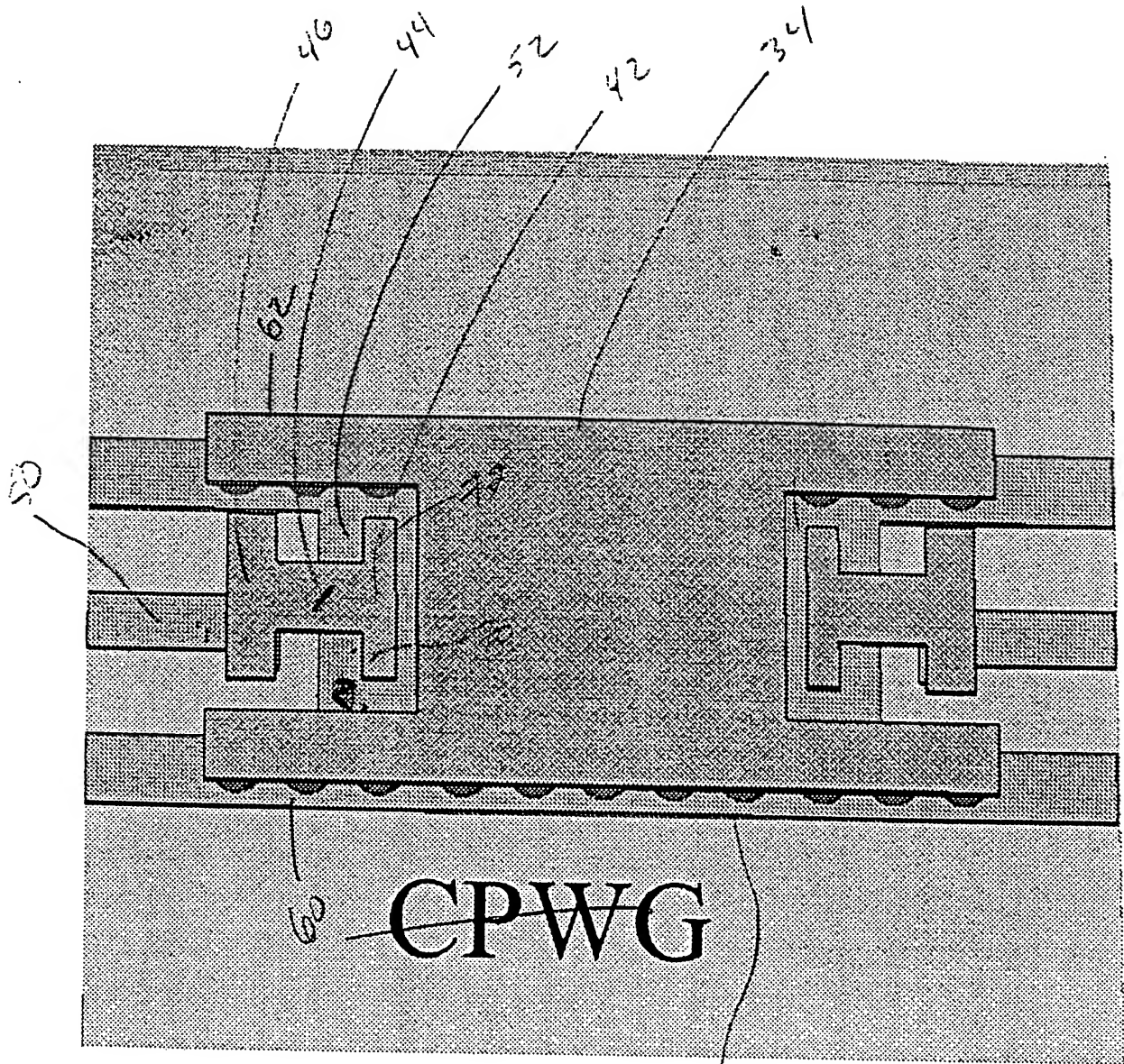
30F10



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50F10



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Fig 6

Comp:

60F10

6. 50 Ohm line on top of carrier and on top of probable eval board (trimmed matching and single bond wire):

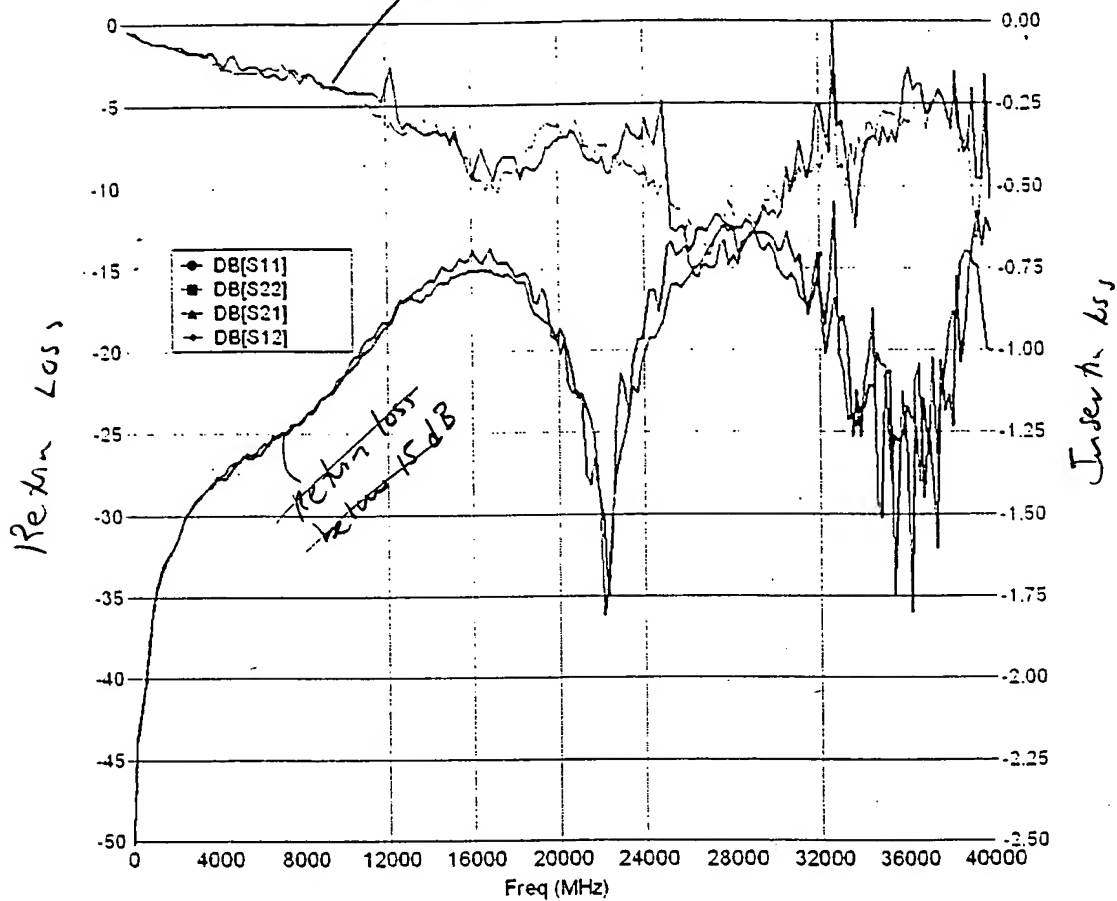
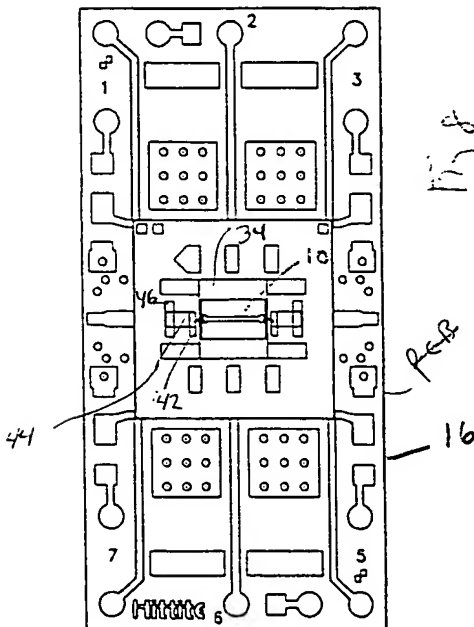
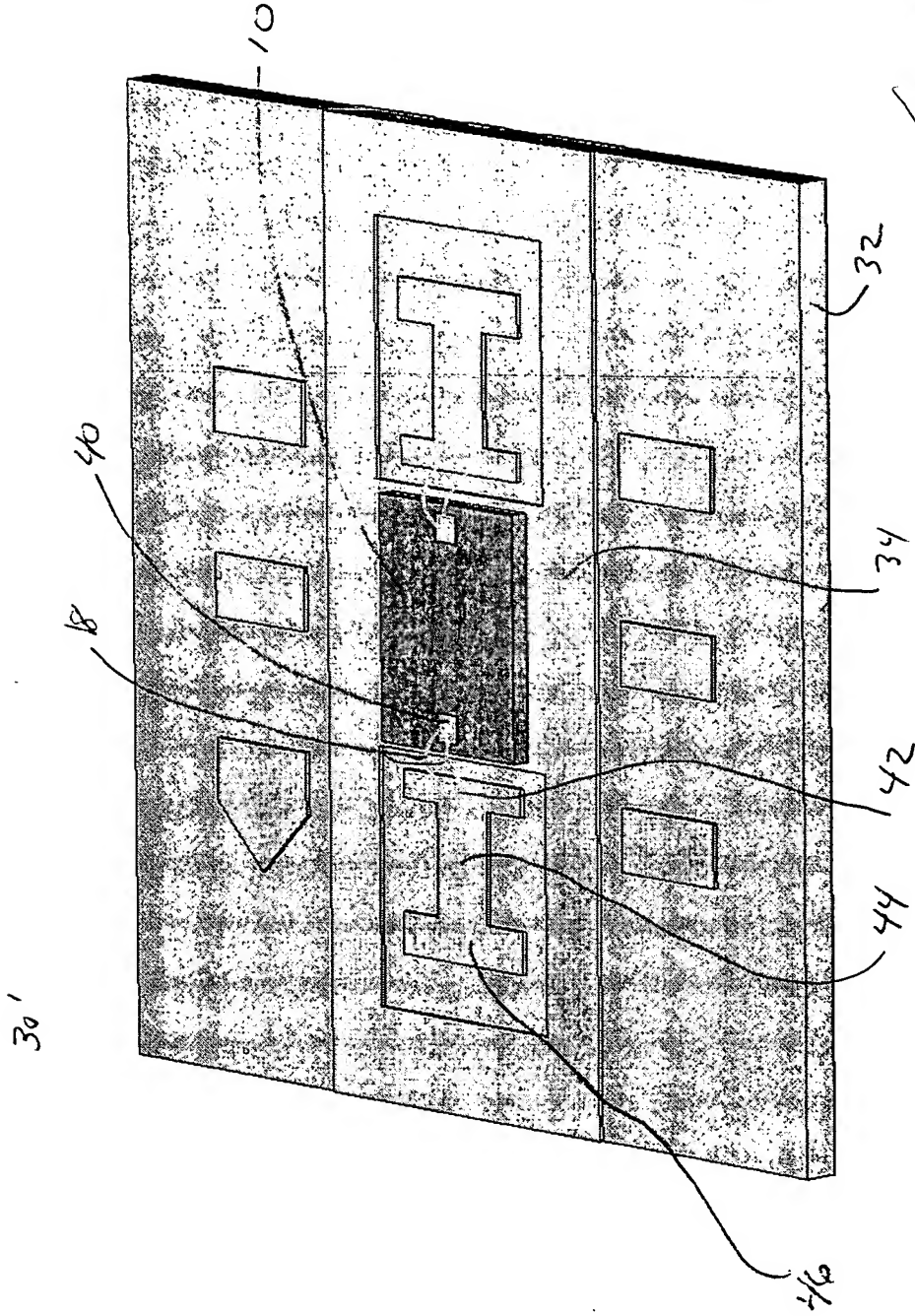


Fig 7



Screenshot



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Fig 9

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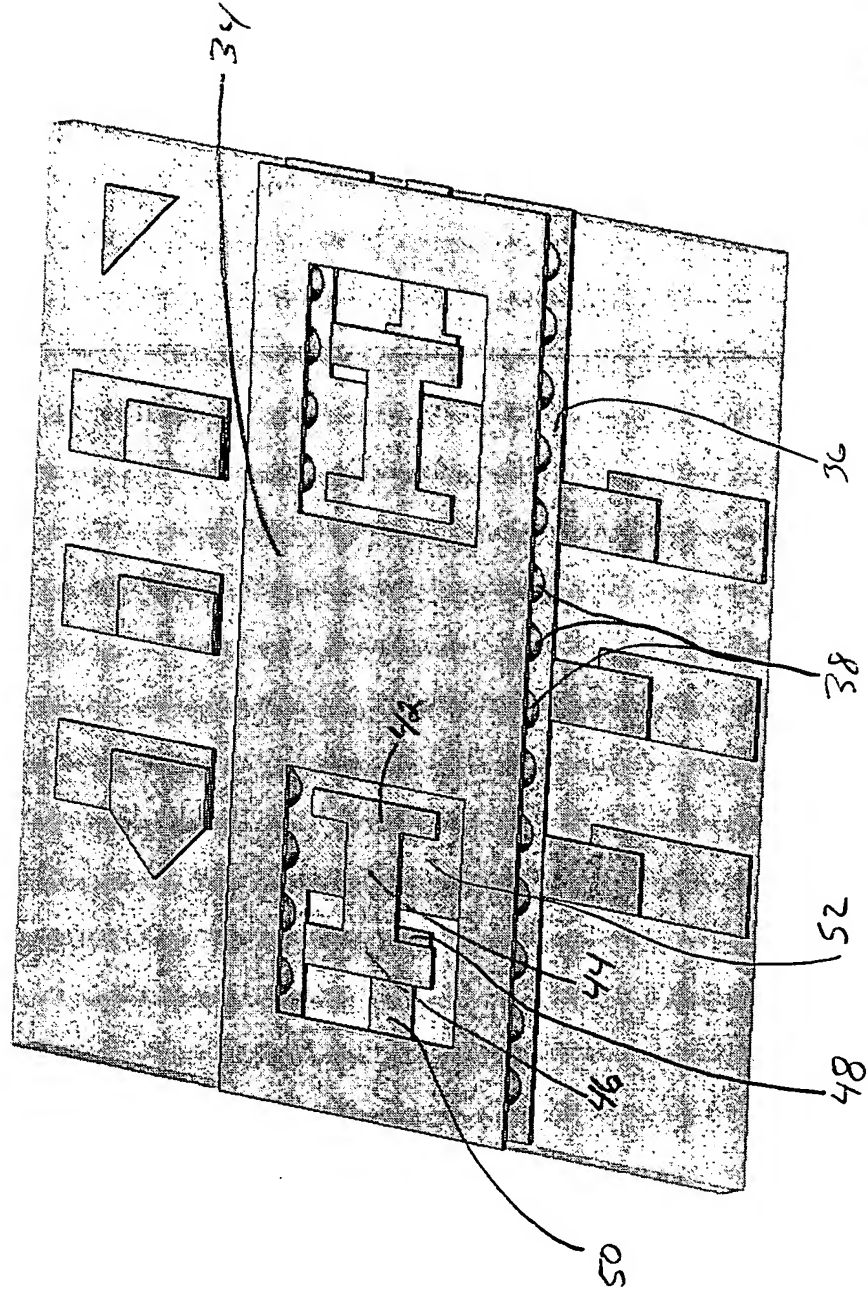
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Screenshot

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Title: RF PACKAGE  
Docket No.: HIT-131J  
Attorney: Kirk Teska, Reg. No. 36,291  
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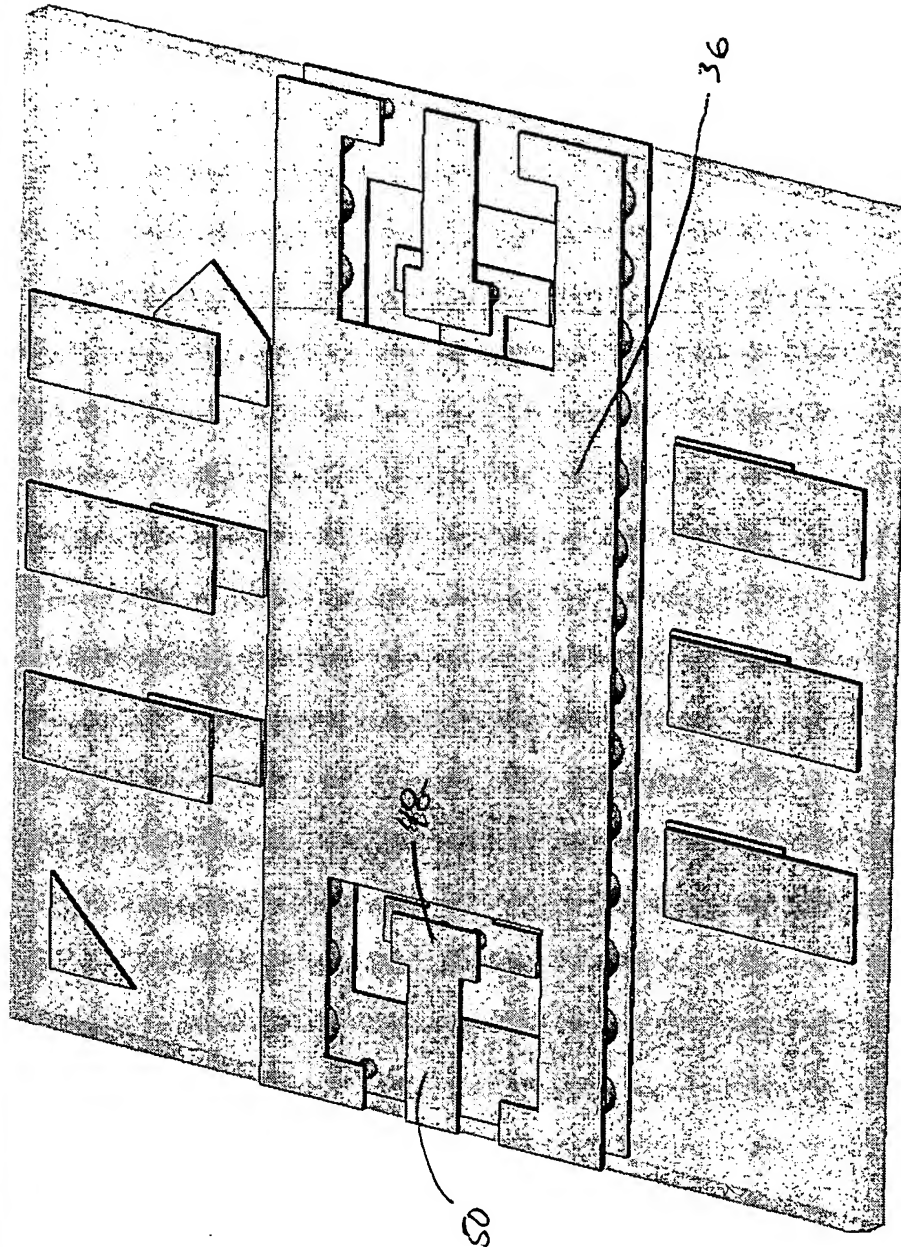
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F311

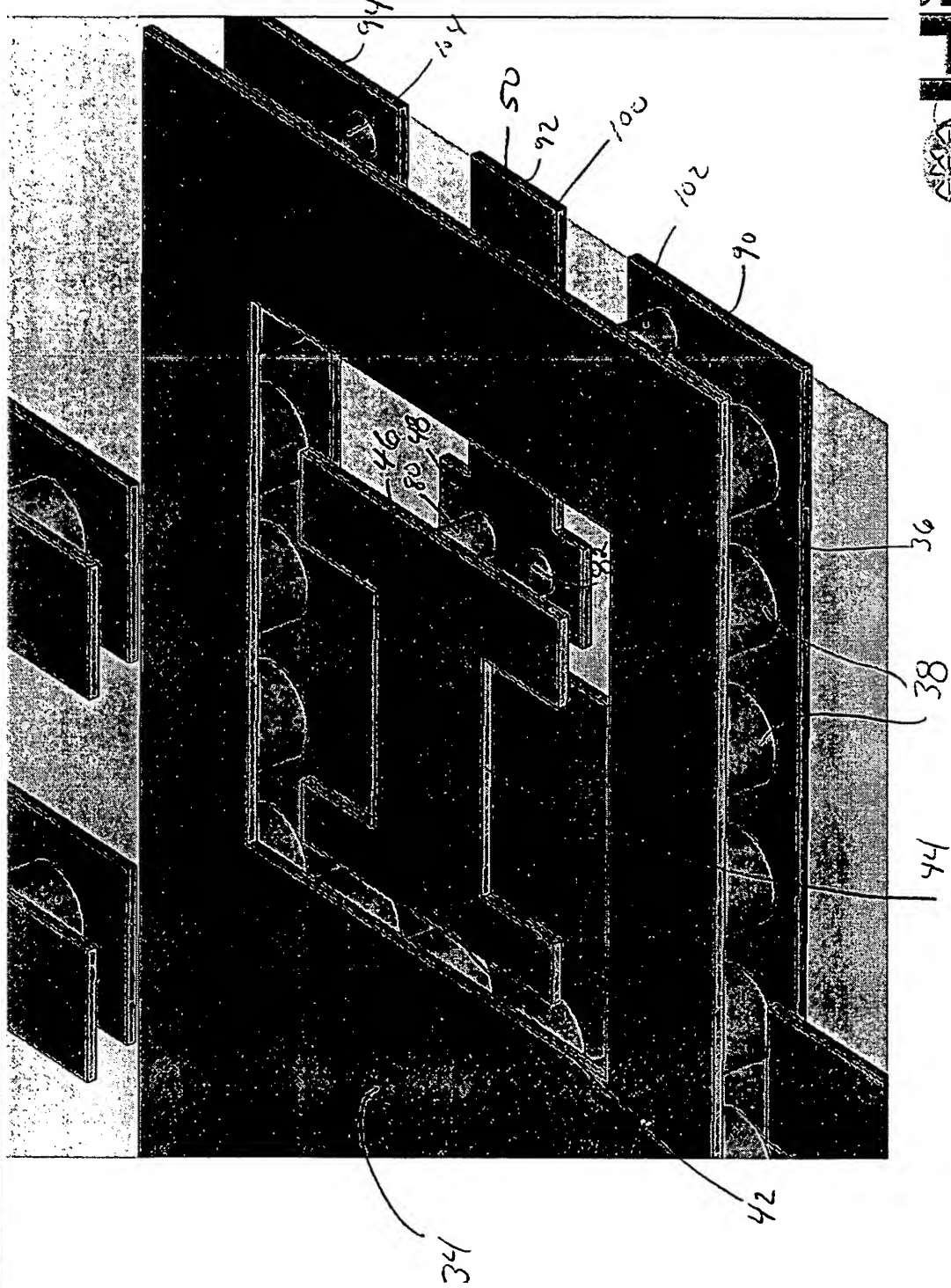
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